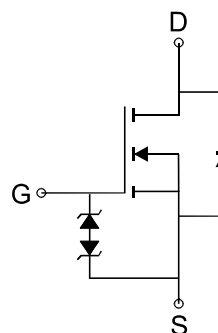
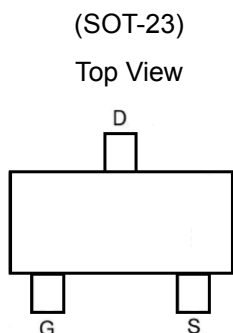


N-Channel 30V (D-S) MOSFET , ESD Protected

GENERAL DESCRIPTION

The ME2306DS is the N-Channel logic enhancement mode power field effect transistors are produced using high cell density , DMOS trench technology. This high density process is especially tailored to minimize on-state resistance. These devices are particularly suited for low voltage application such as cellular phone and notebook computer power management and other battery powered circuits where high-side switching , and low in-line power loss are needed in a very small outline surface mount package.

PIN CONFIGURATION



FEATURES

- $R_{DS(ON)} \leq 31m\Omega @ V_{GS}=10V$
- $R_{DS(ON)} \leq 52m\Omega @ V_{GS}=4.5V$
- ESD Protected
- Super high density cell design for extremely low $R_{DS(ON)}$
- Exceptional on-resistance and maximum DC current capability

APPLICATIONS

- Power Management in Note book
- Portable Equipment
- Load Switch

Ordering Information: ME2306DS(Pb-free)
ME2306DS-G (Green product-Halogen free)

Absolute Maximum Ratings (TA=25°C Unless Otherwise Noted)

Parameter	Symbol	Maximum Ratings	Unit
Drain-Source Voltage	V_{DS}	30	V
Gate-Source Voltage	V_{GSS}	± 20	V
Continuous Drain*	I_D	$T_A=25^\circ C$	5.2
		$T_A=70^\circ C$	4.2
Pulsed Drain Current	I_{DM}	21	A
Maximum Power Dissipation*	P_D	$T_A=25^\circ C$	1.3
		$T_A=70^\circ C$	0.8
Junction and Storage Temperature Range	T_J, T_{stg}	-55 to 150	°C
Thermal Resistance-Junction to Ambient*	$R_{\theta JA}$	90	°C/W

*The device mounted on 1in² FR4 board with 2 oz copper



N-Channel 30V (D-S) MOSFET , ESD Protected

Electrical Characteristics ($T_J = 25^\circ\text{C}$ Unless Otherwise Specified)

Symbol	Parameter	Limit	Min	Typ	Max	Unit
STATIC						
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	30			V
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	1		3	V
I_{GSS}	Gate Leakage Current	$V_{DS}=0V, V_{GS}=\pm 16V$			± 10	μA
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=30V, V_{GS}=0V$			1	μA
$R_{DS(ON)}$	Drain-Source On-Resistance ^a	$V_{GS}=10V, I_D=6.7A$		26	31	m Ω
		$V_{GS}=4.5V, I_D=5.0A$		40	52	
V_{SD}	Diode Forward Voltage	$I_S=1.7A, V_{GS}=0V$		0.8	1.2	V
DYNAMIC						
C_{iss}	Input Capacitance	$V_{DS}=15V, V_{GS}=0V, f=1MHz$		380		pF
C_{oss}	Output Capacitance			64		
C_{rss}	Reverse Transfer Capacitance			41		
Q_g	Total Gate Charge	$V_{DS}=15V, V_{GS}=10V, I_D=6.7A$		11.3		nC
Q_g	Total Gate Charge	$V_{DS}=15V, V_{GS}=4.5V, I_D=6.7A$		5.8		
Q_{gs}	Gate-Source Charge			2.9		
Q_{gd}	Gate-Drain Charge			2.1		
$t_{d(on)}$	Turn-On Delay Time	$V_{DD}=15V, R_L=15\Omega$ $I_D=1.0A, V_{GEN}=10V$ $R_G=6\Omega$		8.8		ns
t_r	Turn-On Rise Time			9.6		
$t_{d(off)}$	Turn-Off Delay Time			31.8		
t_f	Turn-Off Fall Time			3.9		

Notes: a. Pulse test: pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$, Guaranteed by design, not subject to production testing.

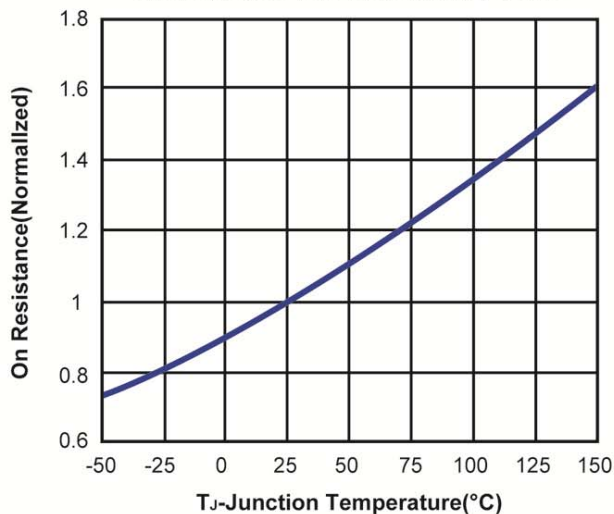
b. Matsuki Electric/ Force mos reserves the right to improve product design, functions and reliability without notice.



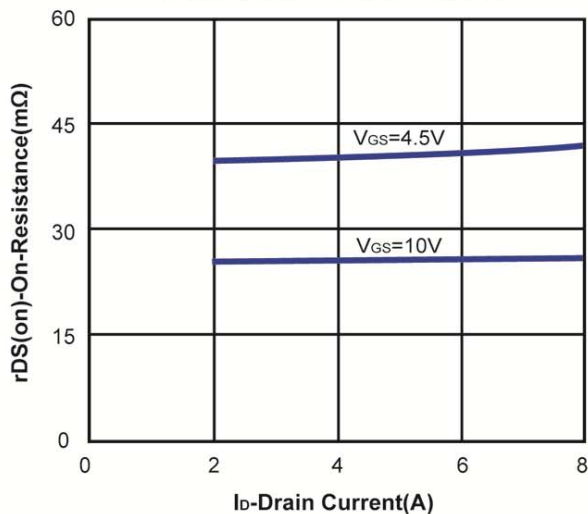
N-Channel 30V (D-S) MOSFET , ESD Protected

Typical Characteristics (T_J =25°C Noted)

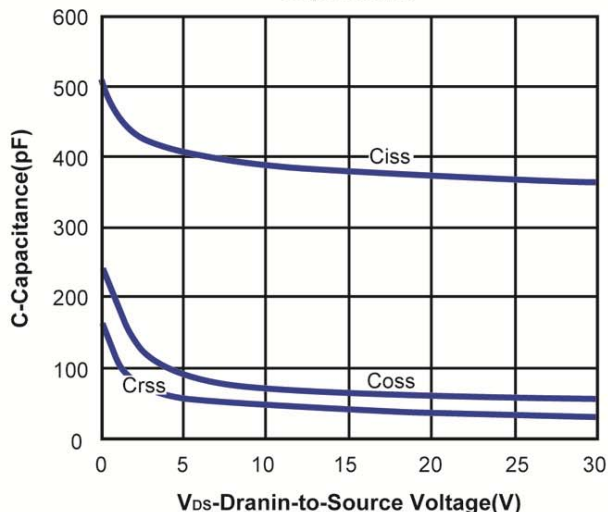
On Resistance vs. Junction Temperature



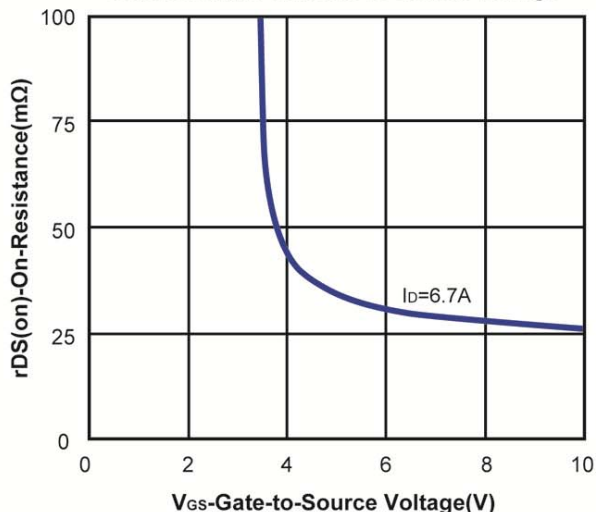
On Resistance vs. Drain Current



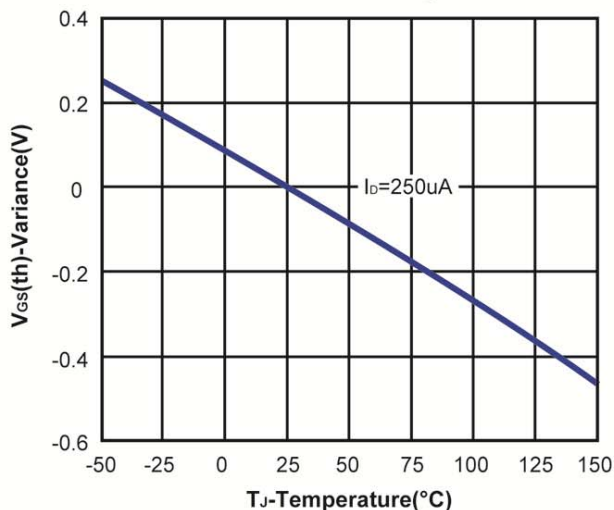
Capacitance



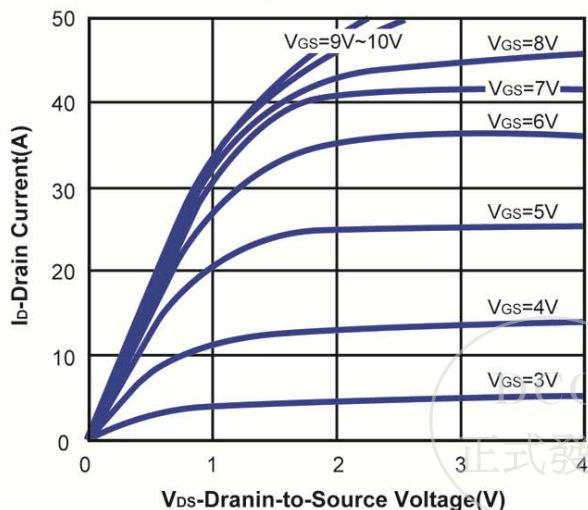
On Resistance vs. Gate-to-Source Voltage



Threshold Voltage

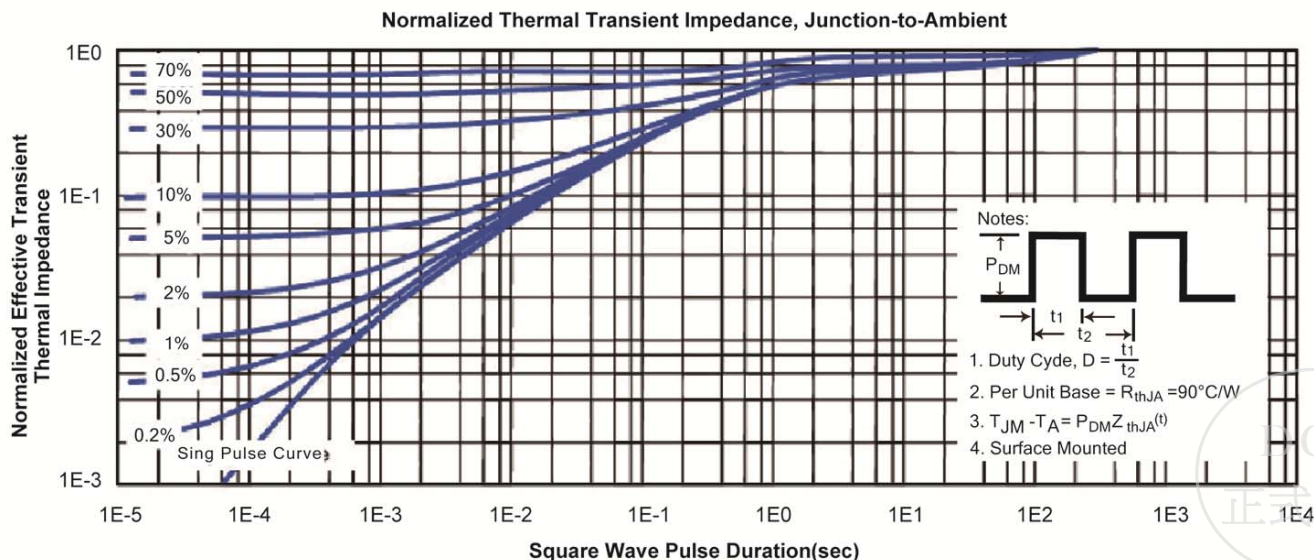
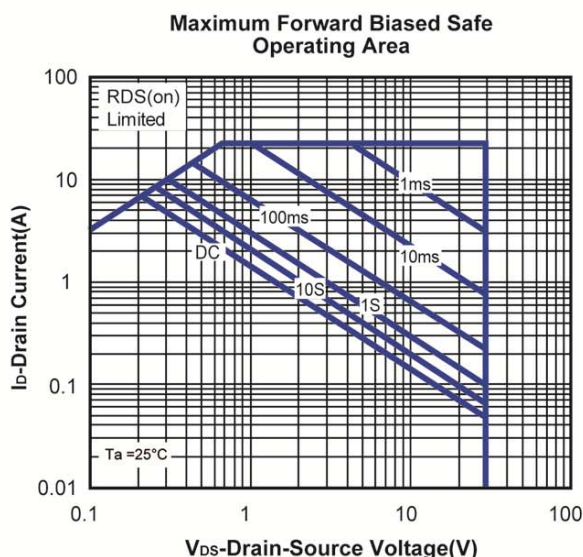
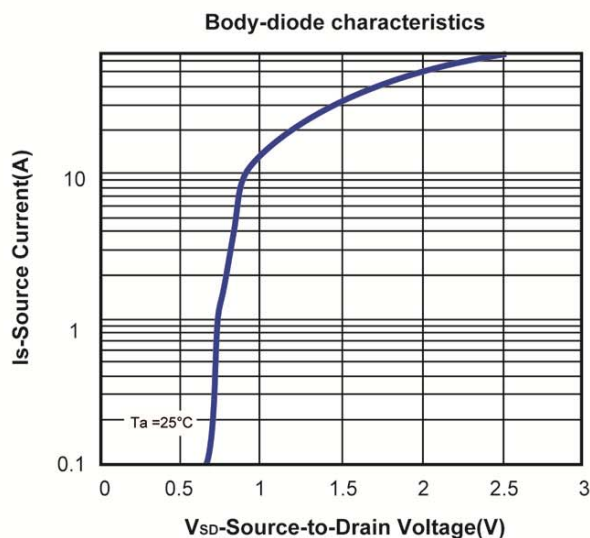
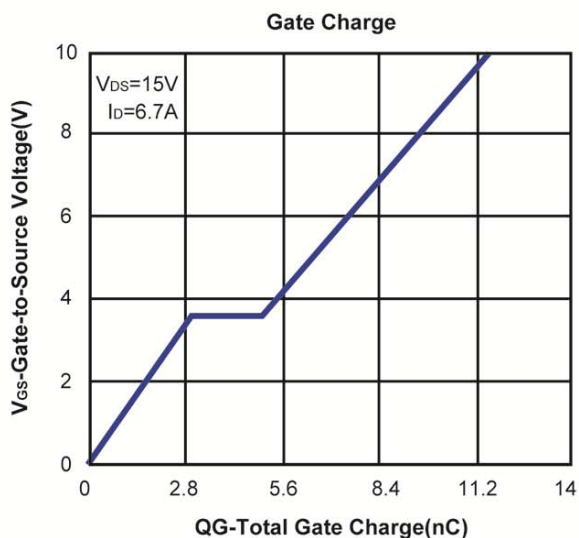


On-Region Characteristics

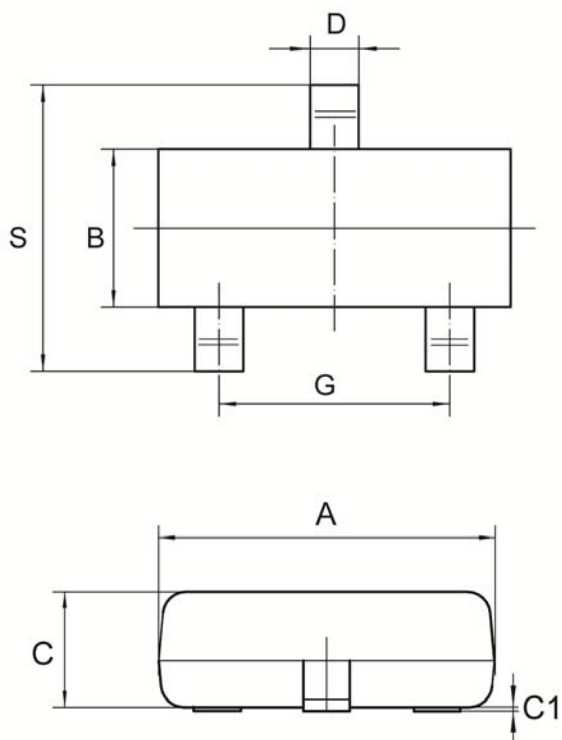


N-Channel 30V (D-S) MOSFET , ESD Protected

Typical Characteristics (T_J =25°C Noted)



SOT-23 Package Outline



Symbol	MILLIMETERS	
	MIN	MAX
A	2.8	3.0
B	1.2	1.4
C	0.9	1.1
C1	-	0.1
D	0.3	0.5
G	1.90 REF	
J	0.05	0.15
K	0.2	-
S	2.2	2.6

